

MOSFET - N-Channel, POWERTRENCH®

100 V, 75 A, 9 m Ω

FDP090N10

Description

This N-Channel MOSFET is produced using onsemi's advance POWERTRENCH process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Features

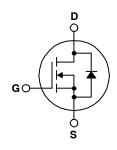
- $R_{DS(on)} = 7.2 \text{ m}\Omega \text{ (Typ)} @ V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low
- High Power and Current Handling Capability
- RoHS Compliant

Applications

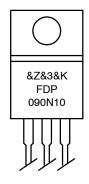
- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micor Solar Inverter



TO-220-3LD **CASE 340AT**



MARKING DIAGRAM



&Z = Assembly Plant Code = 3-Digit Date Code &3

&K = 2-Digit Lot Run Traceability Code

FDP090N10 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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MOSFET MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol		FDP090N10	Unit	
V _{DSS}	Drain to Source Voltage		100	V
V _{GSS}	Gate to Source Voltage		±20	V
I _D	Drain Current	- Continuous T _C = 85°C	75	Α
I _{DM}	Drain Current	- Pulsed (Note 1)	300	Α
E _{AS}	Single Pulse Avalanche Energy	309	mJ	
I _{AR}	Avalanche Current (Note 1)		75	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		20.8	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.6	V/ns
P_{D}	Power Dissipation	T _C = 25°C	208	W
		- Derate Above 25°C	1.39	W/°C
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
T _L	Maximum Lead Temperature for	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	FDP090N10	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.72	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max	62.5	

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit	
OFF CHAF	OFF CHARACTERISTICS						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 V, T_C = 25^{\circ}\text{C}$	100	_	-	V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	0.1	_	V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	μΑ	
		V _{DS} = 100 V, V _{GS} = 0 V, T _C = 150°C	-	-	500		
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA	
ON CHAR	ACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.5	4.5	V	
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 75 A	-	7.2	9	mΩ	
9FS	Forward Transconductance	V _{DS} = 10 V, I _D = 37.5 A	-	100	-	S	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
DYNAMIC	CHARACTERISTICS	·				
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	6185	8225	pF
C _{oss}	Output Capacitance		-	585	775	pF
C _{rss}	Reverse Transfer Capacitance		-	235	355	pF
SWITCHIN	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 50 V, I _D = 75 A,	-	107	224	ns
t _r	Turn-On Rise Time	V_{GS} = 10 V, R_G = 25 Ω (Note 4)	-	322	655	
t _{d(off)}	Turn-Off Delay Time		-	166	342	
t _f	Turn-Off Fall Time		-	149	309	
Q _{g(TOT)}	Total Gate Charge at 10 V	V _{DS} = 50 V, I _D = 75 A V _{GS} = 10 V (Note 4)	-	89	116	nC
Q _{gs}	Gate to Source Gate Charge		-	37	-	
Q_{gd}	Gate to Drain "Miller" Charge		-	22	-	
DRAIN-SC	OURE DIODE CHARACTERISTICS	-			,	
I _S	Maximum Continuous Drain to Source Diode Forward Current		_	-	75	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	300	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 75 A	-	-	1.25	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 75 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	73	-	ns
Q _{rr}	Reverse Recovery Charge		_	166	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Repetitive rating: pulse–width limited by maximum junction temperature.
 2. L = 0.11 mH, I_{AS} = 75 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.
 3. $I_{SD} \le$ 75 A, di/dt \le 200 A/ μ s, $V_{DD} \le$ BV $_{DSS}$, starting T_{J} = 25°C.
 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

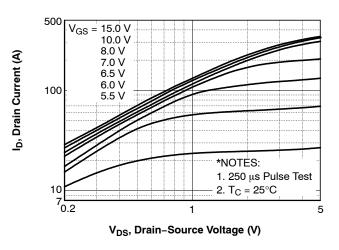


Figure 1. On-Region Characteristics

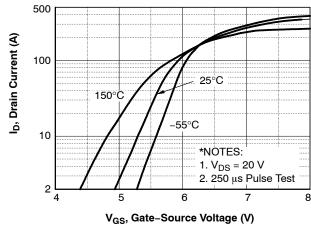


Figure 2. Transfer Characteristics

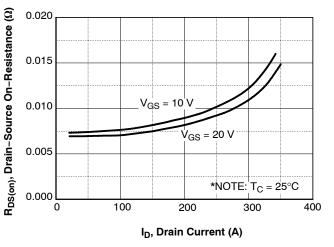


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

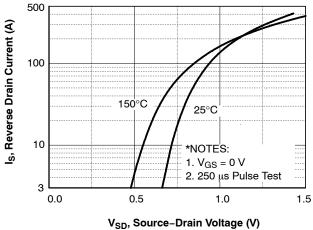


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

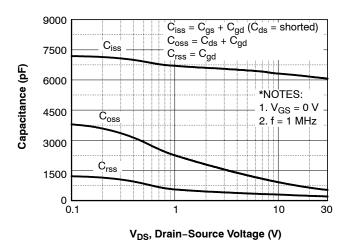


Figure 5. Capacitance Characteristics

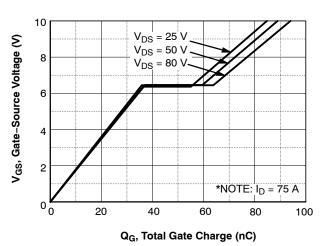


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

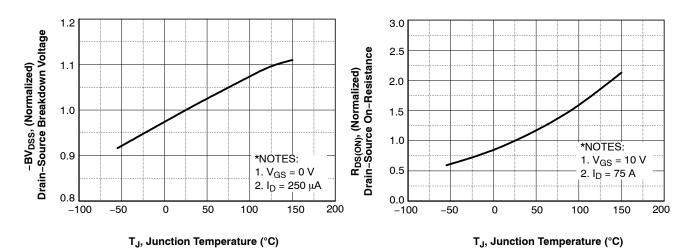


Figure 7. Breakdown Voltage Variation vs. Temperature

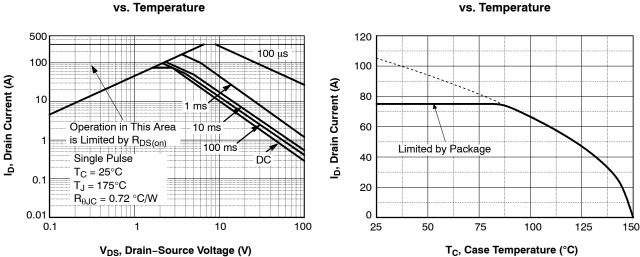
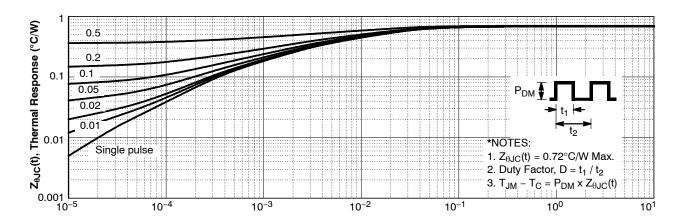


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

Figure 8. On-Resistance Variation



t₁, Rectangular Pulse Duration (s)

Figure 11. Transient Thermal Response Curve

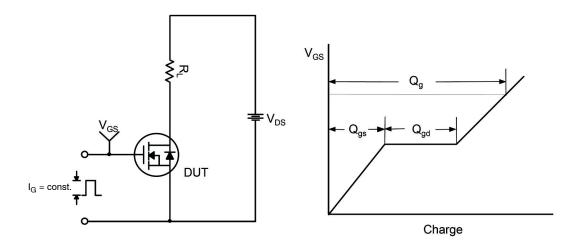


Figure 12. Gate Charge Test Circuit & Waveform

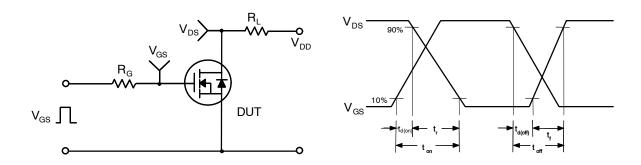


Figure 13. Resistive Switching Test Circuit & Waveforms

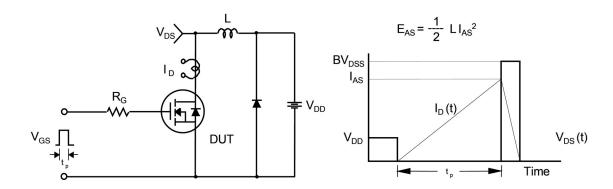


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

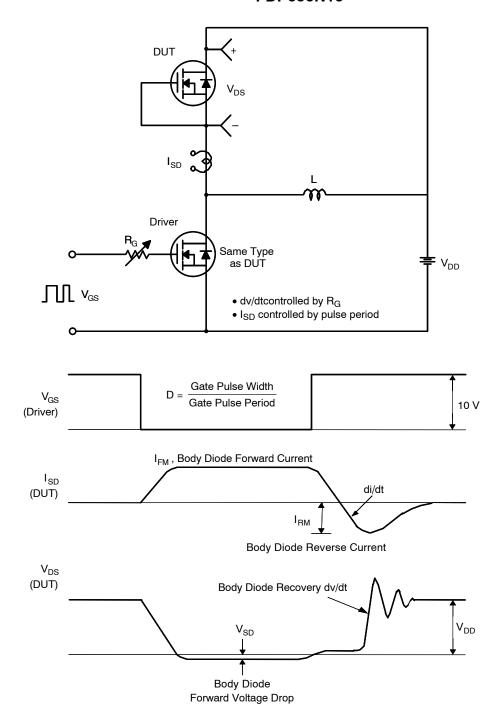
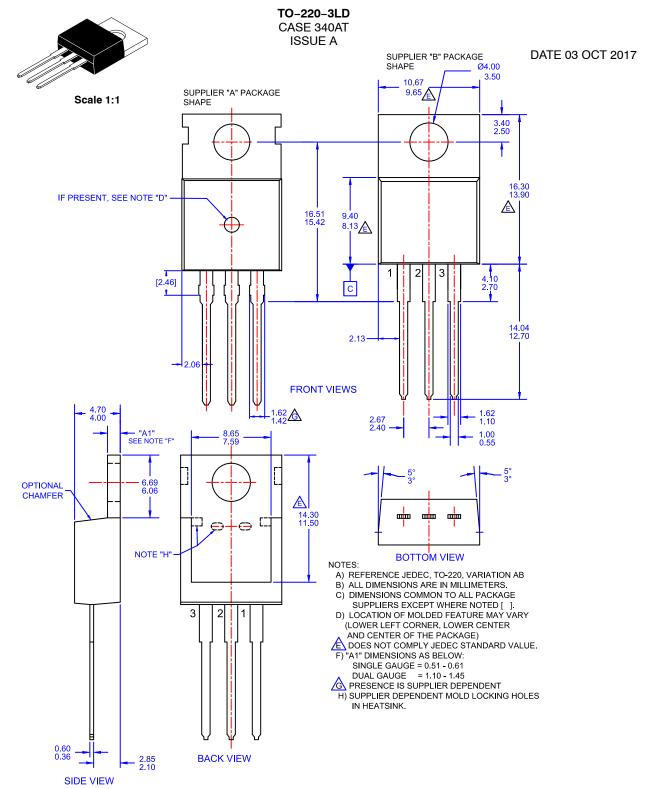


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping
FDP090N10	FDP090N10	TO-220	800 Units / Tube

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